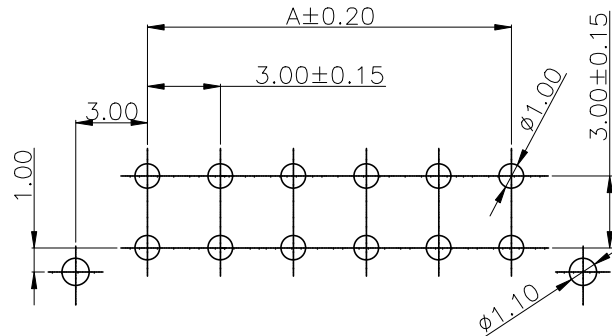
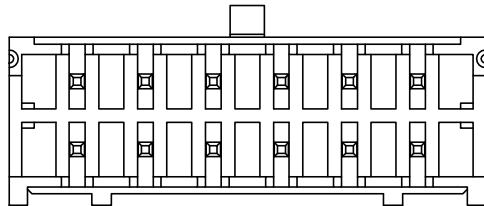
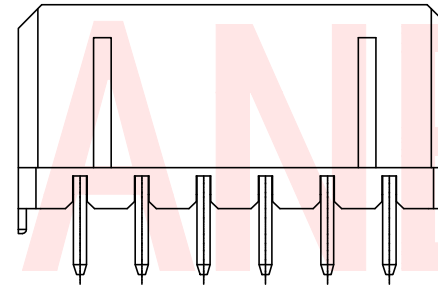
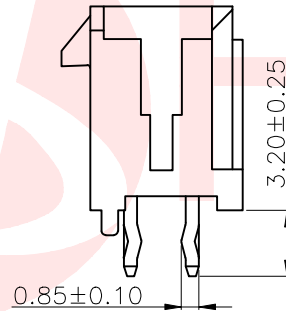
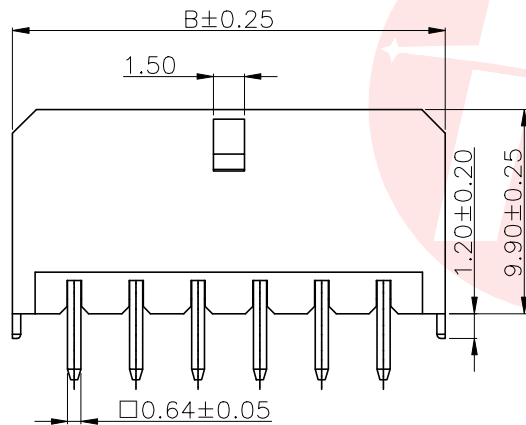
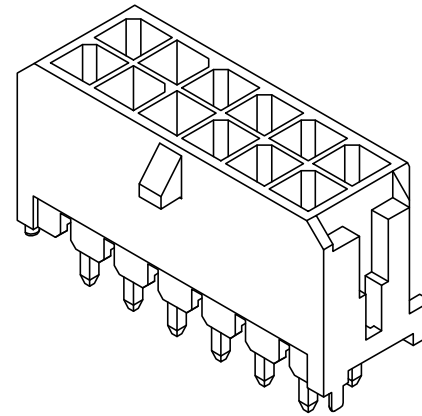
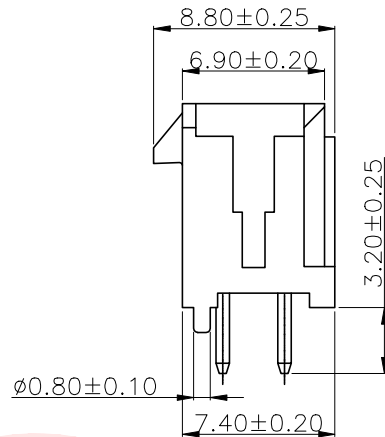
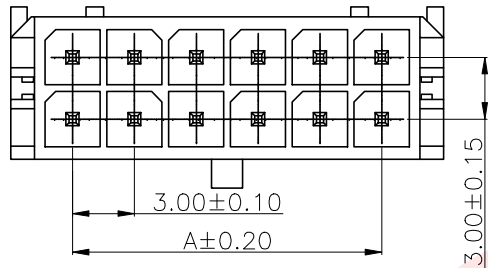




PCB LAYOUT

REV.	ECN NO OR DESCRIPTION	REVISED	DATE

Part No	Pin	A	B
WAFER-MX300ZZ-22A	2	3.00	9.10
WAFER-MX300ZZ-23A	3	6.00	12.10
WAFER-MX300ZZ-24A	4	9.00	15.10
WAFER-MX300ZZ-25A	5	12.00	18.10
WAFER-MX300ZZ-26A	6	15.00	21.10
WAFER-MX300ZZ-27A	7	18.00	24.10
WAFER-MX300ZZ-28A	8	21.00	27.10
WAFER-MX300ZZ-29A	9	24.00	30.10
WAFER-MX300ZZ-210A	10	27.00	33.10
WAFER-MX300ZZ-211A	11	30.00	36.10
WAFER-MX300ZZ-212A	12	33.00	39.10

SPECIFICATIONS

- Current Rating: 5A AC, DC
- Voltage Rating: 250V AC, DC
- Temperatuer Range: -25℃~+85℃
- Contact Resistance: 20mΩ Max
- Insulation Resistance: 1000MΩ Min
- Withstanding Voltang: 1500V AC/minute
- Material: Wafer PBT/PA66, UL94V-0
PIN Brass Tin-plated

UNLESS OTHERWISE
SPECIFIED TOLERANCES

DECIMALS: ANGLES:
X.X :±0.25 X° :±5°
X.XX :±0.15 X.X° :±3°
X.XXX :±0.05



东莞市汉博电子科技有限公司
DONGGUAN HANBO TECHNOLOGY CO., LTD

TITLE	WAFER MX 3.0直针双排带扣		
DWN	xiong	PART NO. WAFER-MX300ZZ-2NA	
CHKD	lee	SCALE:1:1	UNIT: mm
APVD	wang	SIZE: A4	SHEET:10F 1
REV: A4			

CUSTOMER COPY